# Octal D Flip-Flop with Common Clock and Reset

High-Performance Silicon-Gate CMOS

# MC74HC273A, MC74HCT273A

The MC74HC273A/MC74HCT273A is identical in pinout to the LS273. The MC74HC273A inputs are compatible with Standard CMOS outputs; with pull-up resistors, the device is compatible with LSTTL outputs. The MC74HCT273A may be used as a level converter for interfacing TTL or NMOS outputs to high speed CMOS inputs.

The HC273A/HCT273A consists of eight D flip-flops with common Clock and Reset inputs. Each flip-flop is loaded with a low-to-high transition of the Clock input. Reset is asynchronous and active low.

#### Features

- Output Drive Capability: 10 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS and TTL
- Operating Voltage Range: 2.0 to 6.0 V (HC), 4.5 to 5.5 V (HCT)
- Low Input Current: 1.0 μA
- High Noise Immunity Characteristic of CMOS Devices
- In Compliance with the Requirements Defined by JEDEC Standard No. 7 A
- Chip Complexity: 284 FETs or 71 Equivalent Gates
- -Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant

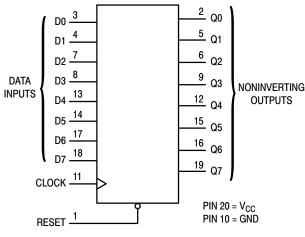


Figure 1. Logic Diagram



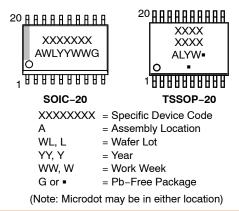


SOIC-20 DW SUFFIX CASE 751D TSSOP-20 DT SUFFIX CASE 948E

PIN ASSIGNMENT

RESET	<b>[</b> 1●	20	þ	V <sub>CC</sub>
Q0	<b>q</b> 2	19	þ	Q7
D0	đз	18	þ	D7
D1	<b>d</b> 4	17	þ	D6
Q1	[5	16	þ	Q6
Q2	6	15	þ	Q5
D2	<b>d</b> 7	14	þ	D5
D3	8]	13	þ	D4
Q3	d 9	12	þ	Q4
GND	<b>[</b> 10	11	þ	CLOCK

#### MARKING DIAGRAMS



FUNCTION TABLE										
	Inputs		Output							
Reset	Clock	D	Q							
L	Х	Х	L							
н	<i>_</i>	Н	н							
н	~	L	L							
н	L	Х	No Change							
Н	$\sim$	Х	No Change							

### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 8 of this data sheet.

#### **MAXIMUM RATINGS**

Symbol	Parameter		Value	Unit
V <sub>CC</sub>	DC Supply Voltage		–0.5 to +6.5	V
V <sub>IN</sub>	DC Input Voltage		–0.5 to V <sub>CC</sub> +0.5	V
V <sub>OUT</sub>	DC Output Voltage		–0.5 to V <sub>CC</sub> +0.5	V
I <sub>IN</sub>	DC Input Diode Current, per Pin		±20	mA
I <sub>OUT</sub>	DC Input Diode Current, Per Pin		±35	mA
I <sub>CC</sub>	DC Supply Current, $V_{CC}$ and GND Pins		±75	mA
I <sub>IK</sub>	Input Clamp Current (V <sub>IN</sub> < 0 or V <sub>IN</sub> > V <sub>CC</sub> )		±20	mA
I <sub>OK</sub>	Output Clamp Current ( $V_{OUT} < 0$ or $V_{OUT} > V_{CC}$ )		±20	mA
T <sub>STG</sub>	Storage Temperature Range		-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 secs		260	°C
TJ	Junction Temperature Under Bias		+150	°C
θ <sub>JA</sub>	Thermal Resistance (Note 1)	SOIC-20W WQFN20 QFN20 TSSOP-20	96 99 111 150	°C/W
P <sub>D</sub>	Power Dissipation in Still Air at 25°C	SOIC-20W WQFN20 QFN20 TSSOP-20	1302 1256 1127 833	mW
MSL	Moisture Sensitivity	SOIC-20W All Other Packages	Level 3 Level 1	-
F <sub>R</sub>	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	-
$V_{\text{ESD}}$	ESD Withstand Voltage (Note 2)	Human Body Model Charged Device Model	> 2000 > 1000	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

 Measured with minimum pad spacing on an FR4 board, using 76 mm-by-114 mm, 2-ounce copper trace no air flow per JESD51-7.
 HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.

3. Tested to EIA/JÉSD78 Class II.

#### **RECOMMENDED OPERATING CONDITIONS**

	2.0	6.0	V
(Note 4)	0	V <sub>CC</sub>	V
e	-55	+125	°C
V <sub>CC</sub> = 2.0 V V <sub>CC</sub> = 4.5 V V <sub>CC</sub> = 6.0 V	0 0 0	1000 500 400	ns
	e (Note 4) e V <sub>CC</sub> = 2.0 V V <sub>CC</sub> = 4.5 V V <sub>CC</sub> = 6.0 V	e (Note 4) 0 e -55	e (Note 4) 0 V <sub>CC</sub> e -55 +125

#### MC74HCT

V <sub>CC</sub>	DC Supply Voltage	4.5	5.5	V
V <sub>IN</sub> , V <sub>OUT</sub>	DC Input Voltage, Output Voltage (Note 4)	0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Free–Air Temperature	55	+125	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise or Fall Time	0	500	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.
Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V<sub>CC</sub>). Unused outputs must be left open.

#### DC ELECTRICAL CHARACTERISTICS (MC74HC273A)

				Gu	aranteed Li	mit	
Symbol	Parameter	Test Conditions	V <sub>CC</sub> V	–55 to 25°C	≤ <b>85</b> °C	≤ 125°C	Unit
V <sub>IH</sub>	Minimum High-Level Input Voltage	$\begin{array}{l} V_{out} = V_{CC} - 0.1 \ V \\  I_{out}  \ \leq \ 20 \ \mu A \end{array}$	2.0 3.0 4.5 6.0	1.5 2.1 3.15 4.2	1.5 2.1 3.15 4.2	1.5 2.1 3.15 4.2	V
V <sub>IL</sub>	Maximum Low-Level Input Voltage	$\begin{array}{l} V_{out} = 0.1 \ V \\  I_{out}  \leq 20 \ \mu A \end{array}$	2.0 3.0 4.5 6.0	0.5 0.9 1.35 1.8	0.5 0.9 1.35 1.8	0.5 0.9 1.35 1.8	V
V <sub>OH</sub>	Minimum High–Level Output Voltage		2.0 4.5 6.0	1.9 4.4 5.9	1.9 4.4 5.9	1.9 4.4 5.9	V
			nA 4.5	2.48 3.98 5.48	2.34 3.84 5.34	2.2 3.7 5.2	
V <sub>OL</sub>	Maximum Low-Level Output Voltage	$\begin{array}{l} V_{in} = V_{IL} \\  I_{out}  \leq 20 \; \mu A \end{array}$	2.0 4.5 6.0	0.1 0.1 0.1	0.1 0.1 0.1	0.1 0.1 0.1	V
			nA 4.5	0.26 0.26 0.26	0.33 0.33 0.33	0.4 0.4 0.4	
l <sub>in</sub>	Maximum Input Leakage Current	V <sub>in</sub> = V <sub>CC</sub> or GND	6.0	±0.1	±1.0	±1.0	μA
I <sub>CC</sub>	Maximum Quiescent Supply Cur- rent (per Package)	$V_{in} = V_{CC} \text{ or } GND$ $I_{out} = 0 \ \mu A$	6.0	4.0	40	160	μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### AC ELECTRICAL CHARACTERISTICS (MC74HC273A)

			Gu	aranteed Li	mit	
Symbol	Parameter	V <sub>CC</sub> V	–55 to 25°C	≤ <b>85°C</b>	≤ 125°C	Unit
f <sub>max</sub>	Maximum Clock Frequency (50% Duty Cycle) (Figures 2 and 3)	2.0 3.0 4.5 6.0	6.0 15 30 35	5.0 10 24 28	4.0 8.0 20 24	MHz
t <sub>PLH</sub> t <sub>PHL</sub>	Maximum Propagation Delay, Clock to Q (Figures 2 and 3)	2.0 3.0 4.5 6.0	145 90 29 25	180 120 36 31	220 140 44 38	ns
t <sub>PHL</sub>	Maximum Propagation Delay, Reset to Q (Figures 2 and 3)	2.0 3.0 4.5 6.0	145 90 29 25	180 120 36 31	220 140 44 38	ns
t <sub>TLH</sub> t <sub>THL</sub>	Maximum Output Transition Time, Any Output (Figures 2 and 3)	2.0 3.0 4.5 6.0	75 27 15 13	95 32 19 16	110 36 22 19	ns
C <sub>in</sub>	Maximum Input Capacitance	-	10	10	10	pF

		Typical @ 25°C, $V_{CC}$ = 5.0 V		
C <sub>PD</sub>	Power Dissipation Capacitance (Per Enabled Output)*	48	pF	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. \*Used to determine the no–load dynamic power consumption:  $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$ .

#### TIMING REQUIREMENTS (MC74HC273A)

					C	Guarante	ed Limi	t		
		v <sub>cc</sub> –		–55 to	25°C	≤ 8	5°C	≤ <b>1</b> 2	25°C	
Symbol	Parameter	Figure	Volts	Min	Max	Min	Max	Min	Max	Unit
t <sub>su</sub>	Minimum Setup Time, Data to Clock	5	2.0 3.0 4.5 6.0	60 23 12 10		75 27 15 13		90 32 18 15		ns
t <sub>h</sub>	Minimum Hold Time, Clock to Data	5	2.0 3.0 4.5 6.0	3.0 3.0 3.0 3.0		3.0 3.0 3.0 3.0		3.0 3.0 3.0 3.0		ns
t <sub>rec</sub>	Minimum Recovery Time, Reset Inactive to Clock	4	2.0 3.0 4.5 6.0	5.0 5.0 5.0 5.0		5.0 5.0 5.0 5.0		5.0 5.0 5.0 5.0		ns
t <sub>w</sub>	Minimum Pulse Width, Clock	3	2.0 3.0 4.5 6.0	60 23 12 10		75 27 15 13		90 32 18 15		ns
t <sub>w</sub>	Minimum Pulse Width, Reset	4	2.0 3.0 4.5 6.0	60 23 12 10		75 27 15 13		90 32 18 15		ns
t <sub>r</sub> , t <sub>f</sub>	Maximum Input Rise and Fall Times	3	2.0 3.0 4.5 6.0		1000 800 500 400		1000 800 500 400		1000 800 500 400	ns

DC ELECTRICAL	<b>CHARACTERISTICS</b>	(MC74HCT273A)
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			Gu	aranteed Li	mit		
Symbol	Parameter	Test Conditions	V <sub>CC</sub> V	–55 to 25°C	≤ <b>85°C</b>	≤ 125°C	Unit
V <sub>IH</sub>	Minimum High-Level Input Voltage	$\begin{array}{l} V_{out} = 0.1 \ V \ or \ V_{CC} - 0.1 \ V \\ \left  I_{out} \right  \leq 20 \ \mu A \end{array} \end{array}$	4.5 5.5	2.0 2.0	2.0 2.0	2.0 2.0	V
V <sub>IL</sub>	Maximum Low-Level Input Voltage	$\begin{array}{l} V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V} \\  I_{out}  \leq 20 \ \mu\text{A} \end{array}$	4.5 5.5	0.8 0.8	0.8 0.8	0.8 0.8	V
V <sub>OH</sub>	Minimum High-Level Output Voltage		4.5 5.5	4.4 5.4	4.4 5.4	4.4 5.4	V
			4.5	3.98	3.84	3.7	
V <sub>OL</sub>	Maximum Low-Level Output Voltage		4.5 5.5	0.1 0.1	0.1 0.1	0.1 0.1	V
			4.5	0.26	0.33	0.4	
l <sub>in</sub>	Maximum Input Leakage Current	V <sub>in</sub> = V <sub>CC</sub> or GND	5.5	±0.1	±1.0	±1.0	μΑ
I <sub>CC</sub>	Maximum Quiescent Supply Current (per Package)	$V_{in} = V_{CC} \text{ or } GND$ $I_{out} = 0 \ \mu A$	5.5	4.0	40	160	μA

$\Delta I_{CC}$	Additional Quiescent Supply Current	$V_{in}$ = 2.4 V, Any One Input $V_{in}$ = V <sub>CC</sub> or GND, Other Inputs		≥ <b>-55°C</b>	25°C to 125°C	
		$I_{out} = 0 \mu A$	5.5	2.9	2.4	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### AC ELECTRICAL CHARACTERISTICS (MC74HCT273A)

		Guaranteed Limit			
Symbol	Parameter	–55 to 25°C	≤ <b>85°C</b>	≤ 125°C	Unit
f <sub>max</sub>	Maximum Clock Frequency (50% Duty Cycle) (Figures 2 and 3)	30	24	20	MHz
t <sub>PLH</sub> , t <sub>PHL</sub>	Maximum Propagation Delay, Clock to Q (Figures 2 and 3)	25	28	35	ns
t <sub>PHL</sub>	Maximum Propagation Delay, Reset to Q	25	28	35	ns
t <sub>TLH</sub> , t <sub>THL</sub>	Maximum Output Transition Time, Any Output (Figures 2 and 3)	18	20	22	ns

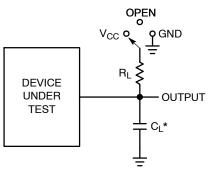
		Typical @ 25°C, V <sub>CC</sub> = 5.0 V	
C <sub>PD</sub>	Power Dissipation Capacitance (Per Gate)*	30	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. \*Used to determine the no-load dynamic power consumption:  $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$ .

#### TIMING REQUIREMENTS (MC74HCT273A)

			Guaranteed Limit						
			–55 to	–55 to 25°C		≤ <b>85°C</b>		≤ 125°C	
Symbol	Parameter	Fig.	Min	Max	Min	Max	Min	Max	Unit
t <sub>su</sub>	Minimum Setup Time, Data to Clock		10		12		15		ns
t <sub>h</sub>	Minimum Hold Time, Clock to Data		3.0		3.0		3.0		ns
t <sub>rec</sub>	Minimum Recovery Time, Set or Reset Inactive to Clock		5.0		5.0		5.0		ns
t <sub>w</sub>	Minimum Pulse Width, Clock	4	12		15		18		ns
t <sub>w</sub>	Minimum Pulse Width, Set or Reset		12		15		18		ns
t <sub>r</sub> , t <sub>f</sub>	Maximum Input Rise and Fall Times	3		500		500		500	ns

## SWITCHING WAVEFORMS



Test	Switch Position	CL	RL
t <sub>PLH</sub> / t <sub>PHL</sub>	Open	50 pF	1 kΩ
t <sub>PLZ</sub> / t <sub>PZL</sub>	V <sub>CC</sub>		
t <sub>PHZ</sub> / t <sub>PZH</sub>	GND		

 $^{*}C_{L}$  Includes probe and jig capacitance



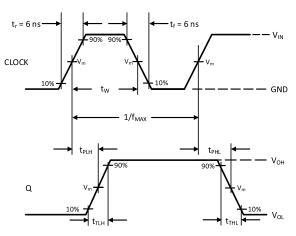
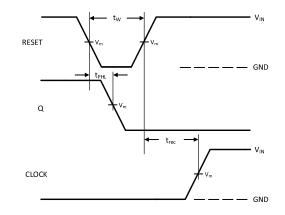
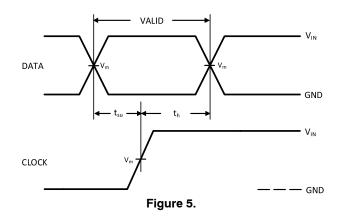


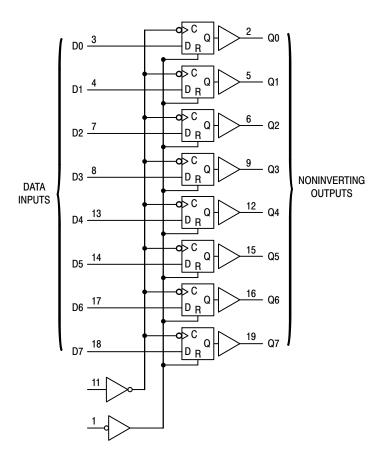
Figure 3.







Device	V <sub>IN</sub> , V	V <sub>m</sub> , V
MC74HC273A	V <sub>CC</sub>	50% x V <sub>CC</sub>
MC74HCT273A	3 V	1.3 V



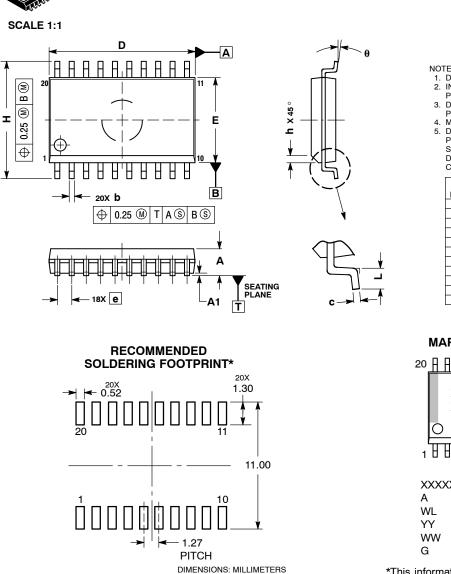


#### **ORDERING INFORMATION**

Device	Marking	Package	Shipping <sup>†</sup>
MC74HC273ADWG	HC273A	SOIC-20 Wide	38 Units / Rail
MC74HC273ADWR2G	HC273A	SOIC-20 Wide	1000 / Tape & Reel
MC74HC273ADWR2G-Q*	HC273A	SOIC-20 Wide	1000 / Tape & Reel
MC74HC273ADTG	HC 273A	TSSOP-20	75 Units / Rail
MC74HC273ADTR2G	HC 273A	TSSOP-20	2500 / Tape & Reel
MC74HC273ADTR2G-Q*	HC 273A	TSSOP-20	2500 / Tape & Reel
MC74HCT273ADWG	HCT273A	SOIC-20 Wide	38 Units / Rail
MC74HCT273ADWR2G	HCT273A	SOIC-20 Wide	1000 / Tape & Reel
MC74HCT273ADWR2G-Q*	HCT273A	SOIC-20 Wide	1000 / Tape & Reel
MC74HCT273ADTR2G	HCT 273A	TSSOP-20	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. \*-Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP

Capable.



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DATE 22 APR 2015

DUSEM

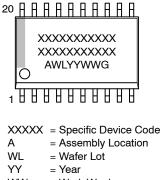
NOTES:

SOIC-20 WB CASE 751D-05 ISSUE H

- 1. DIMENSIONS ARE IN MILLIMETERS. 2. INTERPRET DIMENSIONS AND TOLERANCES
- PER ASME Y14.5M, 1994. 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
- DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS MIN MAX			
DIM				
Α	2.35	2.65		
A1	0.10	0.25		
b	0.35	0.49		
C	0.23	0.32		
D	12.65	12.95		
Е	7.40	7.60		
е	1.27	BSC		
Н	10.05	10.55		
h	0.25	0.75		
L	0.50	0.90		
θ	0 °	7 °		

GENERIC **MARKING DIAGRAM\*** 



= Work Week = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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